

CMOS Transistor Notation

- A CMOS transistor has 3 terminals, called the *gate*, *source*, and *drain*
- V_{AB} is the voltage between nodes A and B in a circuit
- Positive power supply (power source)
 - In TTL, written V_{CC} (usually written VCC)
 - In NMOS and CMOS, written V_{DD} (also VDD)
- Negative power supply (power sink)
 - In TTL, written GND (“ground”)
 - In NMOS and CMOS, sometimes written V_{SS} (also VSS)
- CMOS uses positive logic: VDD is logic “1”, VSS is logic “0”

CMOS Transistors as Switches

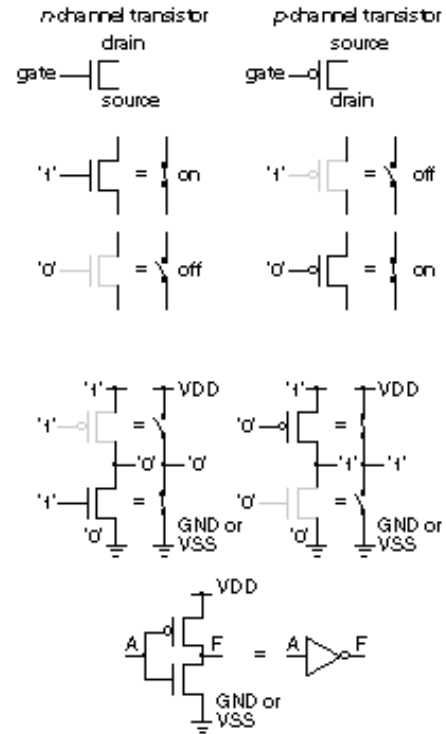


Figure from *Application-Specific Integrated Circuits*, Smith, Addison-Wesley, 1997

CMOS NAND and NOR Gates

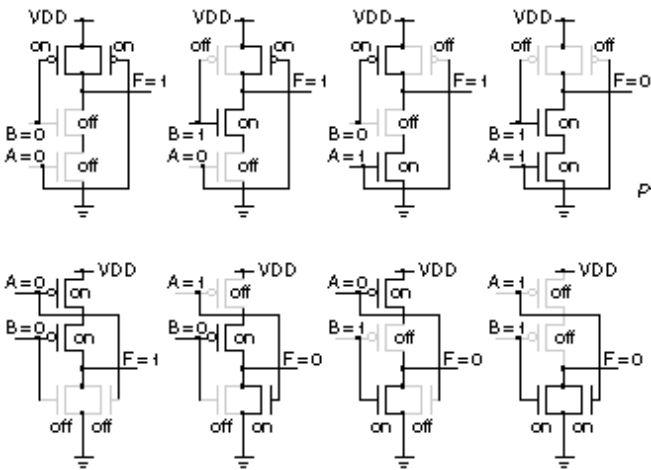


Figure from *Application-Specific Integrated Circuits*, Smith, Addison-Wesley, 1997

- Use two transistors to make a CMOS inverter (as shown on previous slide)
- Use four transistors to make a CMOS 2-input NAND gate
 - Rule of thumb: 1 gate = 4 transistors

IC Fabrication Technologies (Implementing an Inverter)

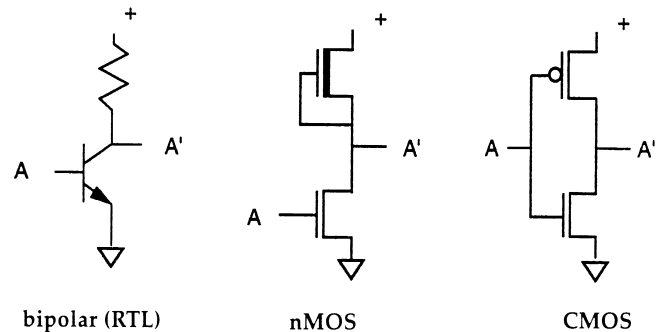


Figure from *Modern VLSI Design*, Wolf, Prentice Hall, 1994

- Bipolar — transistor & resistor (**fastest**)
- NMOS — n-channel depletion mode transistor (top) & n-channel enhancement mode transistor (bottom)
- CMOS — p-channel (**lowest power**) enhancement mode transistor (top) & n-channel enhancement mode transistor (bottom)

Cross-Section of an N-Channel Enhancement Mode MOS Transistor

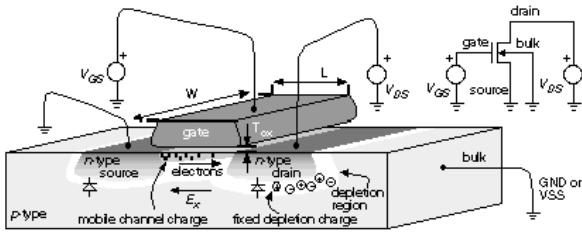


Figure from *Application-Specific Integrated Circuits*, Smith, Addison-Wesley, 1997

- Base is silicon *substrate* (*bulk, well, tub*) that's been *doped* with p-type impurities (full of positively-charged *holes*)
 - Two *diffusion* areas heavily doped with n-type impurities (full of negatively-charged *electrons*) form the *source* and *drain*
 - Transistor action takes place at the *channel*, connecting the source and drain
- A very thin layer of silicon dioxide (SiO_2), called the *gate oxide*, insulates the *gate*, made of polysilicon, from the channel

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Operation of an N-Channel Enhancement Mode MOS Transistor

- Works as a switch — gate-to-source voltage regulates the amount of current that can flow between drain and source
 - When $V_{GS} = 0$, the p-type channel is full of *holes*, and the n-type source and drain contain *electrons*
 - The p-n junctions at source and drain form *diodes* in opposite directions, so no current flows between source and drain
 - As V_{GS} rises above 0, the few n-type impurities that are present in the p-type channel start to attract electrons
 - The electrons migrate toward the (positively charged) gate, but are stopped by the gate oxide, so collect at the top of the channel
 - When V_{GS} rises to the *threshold voltage* (V_t), enough electrons have collected to form an *n-channel inversion layer*, which allows electrons to flow from source to drain (current flows from drain to source)

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Operation of an N-Channel Enhancement Mode MOS Transistor (cont.)

- N-channel vs. p-channel
 - N-channel: V_{GS} and V_{DS} both positive, gate and source are n-type (electrons), substrate & channel is p-type (holes), when $V_{GS} \gg V_t$ electrons accumulate in channel and flow from source to drain, current flows from drain to source
 - P-channel: V_{GS} and V_{DS} both negative, gate and source are p-type (holes), substrate & channel is n-type (electrons), when $V_{GS} \gg$ (more negative) than V_t holes accumulate in channel and flow from source to drain, current flows from source to drain
- Current proportional to W/L of transistor
 - Length (L) = parallel to current flow
 - As W increases, more current can flow
 - As L increases, less current flows

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